

# 800mA Single Cell Linear Li-Ion Battery Charger

## 1 Feature

- Input Withstand Voltage 36V
- Input Overvoltage Protection 6.8V
- Standby Current Less Than 1 $\mu$ A
- High-Precision Full Charge Detection Voltage Threshold
- Support 0V Battery Charging
- Up to 800mA Programmable Charge Current
- Trickle/Constant Current/Constant Voltage Three-Stage Charging
- 2.8 V Trickle Switching Threshold
- Automatic Recharging
- Battery Reverse Polarity Protection
- Adjustable Charging Current with Intelligent Thermal Regulation
- LED Status Indication Output Pin
- SOT23-5 Package
- RoHS Compliant

## 2 Applications

- Capacitive Sensors
- Toy
- Bluetooth Applications
- Lithium-ion Battery Powered Devices

## 3 Description

GD30BC1500 is a complete constant current/constant voltage linear charger for single-cell lithium batteries. Its compact package and low number of external components make GD30BC1500 very suitable for portable applications. It adopts PMOSFET architecture and anti-backflow circuit internally, so no external detection resistor and isolation diode are required. Thermal feedback can regulate the charging current to limit the chip power consumption under high power operation or high temperature environment conditions. The full charge voltage is fixed at 4.2V, and the charging current can be programmed by the ISET external resistor.

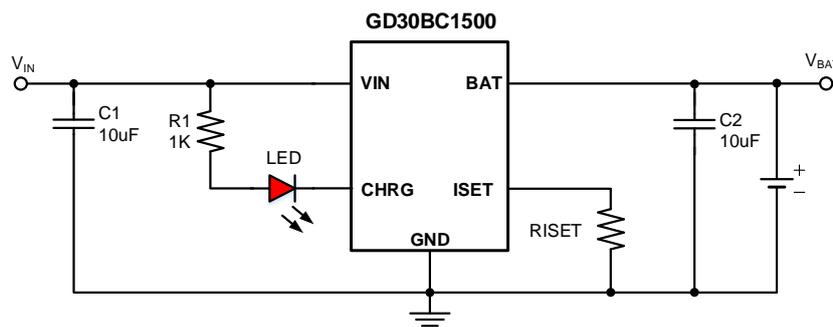
When the final full charge voltage is reached and the charge current drops to 1/10 of the set current, the GD30BC1500 will automatically terminate the charge cycle. When the input voltage source is removed, the GD30BC1500 automatically enters a low power state and the port leakage current connected to the battery drops below 1 $\mu$ A. Other features include charge current monitor, under-voltage lockout, automatic charging and status pins.

### Device Information<sup>1</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
GD30BC1500	SOT23-5	2.92mm x 1.62mm

1. For packaging details, see [Packaging information](#) section.

## Simplified Application Schematic

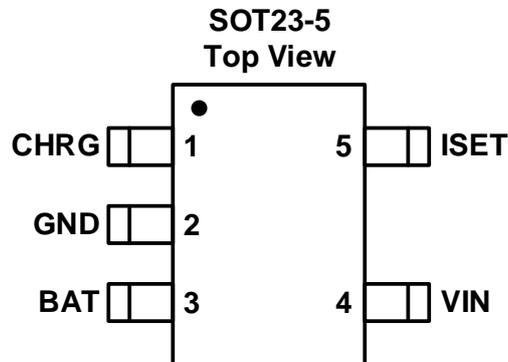


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## 4 Device Overview

### 4.1 Pinout and Pin Assignment



### 4.2 Pin Description

PINS		PIN TYPE <sup>1</sup>	FUNCTION
NAME	NUM		
CHRG	1	O	Open-drain output for charging status indicator.
GND	2	G	Ground pin.
BAT	3	P	Charging current output pin.
VIN	4	P	Power input pin, connected to the adapter.
ISET	5	I	Charge current programming, by connecting a 1% resistor ( $R_{ISET}$ ) to ground to program the charge current.

1. I input, P = power, G = ground.

## 5 Parameter Information

### 5.1 Absolute Maximum Ratings

Exceeding the operating temperature range(unless otherwise noted)<sup>1</sup>

SYMBOL	PARAMETER	MIN	MAX	UNIT
V <sub>IN</sub>	Input voltage	-0.3	36	V
V <sub>CHRG</sub>	Status indication pin withstand voltage	-0.3	36	V
V <sub>BAT</sub>	Battery voltage	-5	12	V
V <sub>ISET</sub>	ISET pin withstand voltage	-0.3	6	V
T <sub>J</sub>	Junction temperature	-40	150	°C
T <sub>stg</sub>	Storage temperature range	-55	150	°C

1. Stresses exceeding these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only and functional operation of the device at these or any other conditions beyond those specified is not implied.

### 5.2 Recommended Operating Conditions

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
V <sub>IN</sub>	Input voltage range	4.5	5	6	V
I <sub>CH</sub>	Constant current charging current			0.8	A
T <sub>J</sub>	Operating junction temperature <sup>1</sup>	-40		125	°C
T <sub>A</sub>	Working environment temperature <sup>1</sup>	-40		85	°C

1. Power consumption and thermal limitations must be considered.

### 5.3 Electrical Sensitivity

SYMBOL	CONDITIONS	VALUE	UNIT
V <sub>ESD(HBM)</sub>	Human-body model (HBM), ANSI/ESDA/JEDEC JS-001-2017 <sup>1</sup>	±2000	V
V <sub>ESD(CDM)</sub>	Charge-device model (CDM), ANSI/ESDA/JEDEC JS-002-2022 <sup>2</sup>	±200	V

1. JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
2. JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 5.4 Thermal Resistance

SYMBOL <sup>1</sup>	CONDITIONS	PACKAGE	VALUE	UNIT
Θ <sub>JA</sub>	Natural convection, 2S2P PCB	SOT23-5	210	°C/W

1. Thermal characteristics are based on simulation, and meet JEDEC document JESD51-7.

## 5.5 Electrical characteristics

$V_{IN} = 5V$ ,  $C_1 = 10\mu F$ ,  $C_2 = 10\mu F$ ,  $T_A = 25^\circ C$ , unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
<b>POWER SUPPLY</b>						
$V_{IN}$	Input voltage range		4.5	5	6	V
$I_{IN-IBAT}$	Input power current	Charging Mode ( $R_{ISET} = 2K$ )		240	360	$\mu A$
$V_{OVP}$	Input overvoltage protection	$V_{IN}$ rises	6.3	6.8	7.3	V
$V_{OVP\_HYS}$	Input overvoltage protection hysteresis			500		mV
$V_{UVLO}$	VIN undervoltage lockout threshold	$V_{IN}$ drops		3.8		V
$V_{UVLO\_HYS}$	VIN undervoltage lockout threshold hysteresis			200		mV
<b>BATTERY CHARGING</b>						
$V_{FLOAT}$	Stable output ( full charge voltage)	$V_{BAT}$ from low to high	4.158	4.2	4.242	V
$\Delta V_{RCHG}$	Recharge hysteresis voltage	$V_{FLOAT} - V_{RCHG}$		150		mV
$R_{DS\_ON}$	Power tube conduction internal resistance	$V_{BAT} = 3.8V$ , $R_{ISET} = 2k\Omega$		700		$m\Omega$
$I_{CH}$	Constant current charging current	$V_{IN} = 5V$ , $V_{BAT} = 3.6V$ , $R_{ISET} = 1.3k\Omega$		770		mA
$I_{BAT}$	BAT pin current	$V_{IN}$ is left floating, $V_{BAT} = 4.0V$		0.5	1	$\mu A$
$V_{TRIKL}$	Trickle charge threshold voltage	$V_{BAT}$ rises		2.8		V
$V_{TRIKL\_HYS}$	Trickle charge threshold voltage hysteresis			150		mV
$I_{TRIKL}$	Trickle charge current	$V_{BAT} < V_{TRIKL}$		$10\% * I_{CH}$		mA
$I_{EOC}$	Termination charge current threshold			$10\% * I_{CH}$		mA
$V_{ISET}$	ISET pin voltage during constant current charging	$V_{IN} = 5V$ , $R_{ISET} = 2K$	0.85	1	1.15	V
$I_{ISET}$	ISET pin current			1		$\mu A$
<b>LED INDICATION</b>						
$I_{sink}$	CHRG pin pull-down current	$V_{IN} = 5V$ , $V_{CHRG} = 1V$	1	2.5	5	$\mu A$
<b>INTERNAL TEMPERATURE COMPENSATION</b>						
$T_{OTC}$	Internal temperature compensation			130		$^\circ C$

## 6 Functional Description

### 6.1 Block Diagram

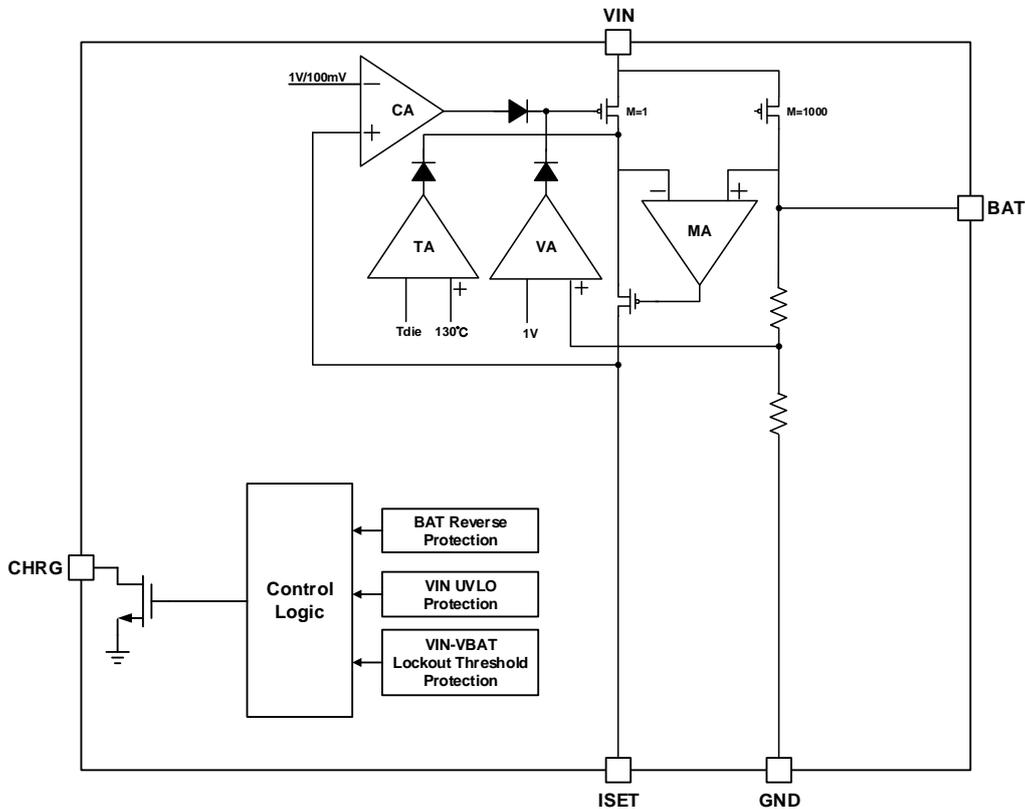


Figure 1. GD30BC1500 Functional Block Diagram

### 6.2 Operation

The GD30BC1500 is a complete constant current/constant voltage linear charger for single-cell lithium batteries. Its compact package and low external component count make the GD30BC1500 ideal for portable applications. The thermal feedback can adjust the charging current to limit the power consumption of the chip under high-power operation or high-temperature environment conditions. The complete charging process includes trickle pre-charging, constant current charging, constant voltage charging and automatic recharging, as shown in Figure 2. The full charge voltage is fixed at 4.2V, and the constant current charging current can be programmed through the ISET external resistor. When the final full charge voltage is reached, the charging current drops to 1/10. When the constant current is used, the GD30BC1500 will automatically terminate the charge cycle. When the input voltage source is removed, the GD30BC1500 automatically enters a low power state, and the leakage current of the port connected to the battery drops below 1 $\mu$ A. Other features include charge current monitor, undervoltage lockout, automatic charging and status pins.

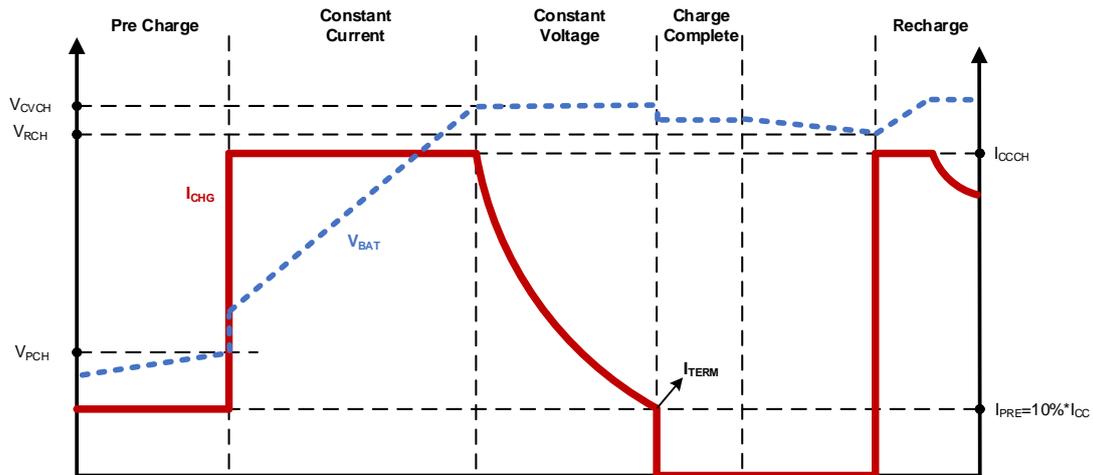


Figure 2. Lithium Battery Cycle Charging Process

### 6.2.1 Charging

When the input voltage is below 3.8V or above 6.8V, the charger IC will automatically disable. When a battery is connected to the charger output and the voltage at the VIN pin rises above 4.5V, a charging cycle begins. If the BAT pin voltage is below 2.8V, the charger enters trickle charge mode. In this mode, the GD30BC1500 provides approximately 1/10 of the ISET programmed charging current to bring the battery voltage to a safe level for full current charging. When the BAT pin voltage rises above 2.8V, the charger enters constant current mode (CC), and the ISET programmed charging current is supplied to the battery. When the BAT pin voltage approaches the final full charge voltage, the GD30BC1500 enters constant voltage mode (CV), and the charging current gradually decreases. When the charging current in CV mode decreases to 1/10 of the programmed current, the battery is fully charged. The status is indicated.

### 6.2.2 Charge Termination

The charging cycle is terminated when the charging current drops to 1/10 of the set value after reaching the final full charge voltage.

### 6.2.3 ISET Programmable Charge Current

Set by a resistor connected between the ISET pin and ground. The set resistor and charge current are calculated using the following Equation(1), where R<sub>ISET</sub> is in ohms (Ω).

$$I_{BAT} = \frac{1000}{R_{ISET}} \quad (1)$$

In order to ensure the stability and temperature characteristics of the system, it is recommended to use a metal film resistor with an accuracy of 1% for R<sub>ISET</sub>. In specific applications, the charging current can be reasonably set according to the actual system requirements and ambient temperature. The relationship between R<sub>ISET</sub> and the charging current is as follows:

R <sub>ISET</sub> (KΩ)	I <sub>CH</sub> (mA)
1.3	770
2	500

$R_{ISET}$ (K $\Omega$ )	$I_{CH}$ (mA)
5	2 00
10	1 00

### 6.2.4 Automatic Recharging

Once the charge cycle is terminated, the GD30BC1500 continuously monitors the voltage on the BAT pin using a comparator with a 1.8 ms filter time . When the battery voltage drops below 4.05V (roughly corresponding to 80% to 90% of the battery capacity), the charge cycle restarts. This ensures that the battery is maintained at (or close to) a fully charged state and eliminates the need for periodic charge cycle initiations.

### 6.2.5 Undervoltage Lockout

The built-in undervoltage lockout circuit monitors the input voltage and keeps the charger in shutdown mode until VIN rises above the undervoltage lockout threshold. The UVLO circuit will keep the charger in shutdown mode. If the UVLO comparator is tripped, the charger will not exit shutdown mode until VIN rises 200mV above the battery voltage .

### 6.2.6 Reverse Battery Protection

GD30BC1500 integrates a reverse battery protection circuit, which can effectively prevent chip damage caused by reverse battery connection during assembly or application. When the BAT pin voltage is 200mV lower than the GND voltage, the internal charging circuit is closed. when the BAT pin voltage rises back to 10mV lower than the GND voltage, it is judged that the battery is connected normally, and the charging cycle is restarted.

### 6.2.7 LED Status Indicator

There are two different charging states, one is charging and the other is charging completed. The CHRG pin is pulled low in the charging state and becomes high impedance in the charging completed state.

CHARGING STATUS	RED LED (CHRG)
Charge	Bright
Fully charged	Destroy
Undervoltage lockout, overvoltage, abnormal battery temperature	Destroy
VIN connected, battery not connected	Bright

### 6.2.8 Intelligent Temperature Control

If the chip temperature rises above a preset value of 130°C, an internal thermal feedback loop will reduce the charge current. This feature prevents the GD30BC1500 from overheating and allows the user to increase the upper limit of a given board's power handling capability without the risk of damaging the GD30BC1500. The charge current can be set based on typical (rather than worst-case) ambient temperature, with the assurance that the charger will automatically reduce the current in the worst case.

### 6.2.9 Power Dissipation

The chip junction temperature depends on many factors such as ambient temperature, PCB layout, load and package



type. The power consumption and chip junction temperature can be calculated according to the following [Equation\(2\)](#):

$$P_D = R_{DS(ON)} \times I_{OUT}^2 \quad (2)$$

According to the PD junction temperature, it can be calculated by the following [Equation\(3\)](#):

$$T_J = P_D \times \theta_{JA} + T_A \quad (3)$$

Where:

$T_J$  is the chip junction temperature,  $T_A$  is the ambient temperature,  $\theta_{JA}$  is the package thermal resistance.

## 7 Application Information

GD30BC1500 is a linear charger for single-cell lithium-ion batteries. It has a 36V input voltage, a 5V typical input voltage, and a lithium-ion battery full charge voltage of 4.2V.

### 7.1 Typical Application Circuit

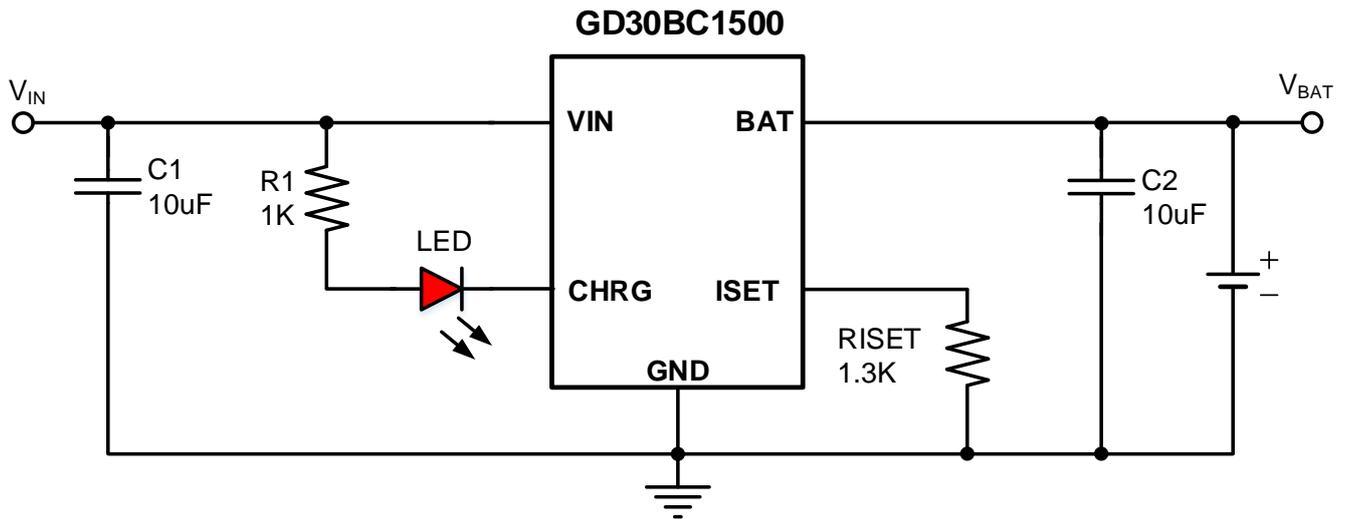


Figure 3. 500mA Constant Current Charging Reference Circuit

## 8 Layout Guidelines and Example

For the best finishing performance, place all circuit components on the same layer of the circuit board and as close to the chip pins as possible. The input and output capacitor return paths and the chip GND pins are connected to the same ground plane, which needs to be widened, and the input and output capacitors are placed as close to the chip pins as possible. It is not recommended to use vias and long traces for input and output capacitors, which will have a negative impact on system performance. The grounding scheme shown in [Figure 4](#) minimizes parasitic inductance, thereby reducing load current transients, minimizing noise, and improving circuit stability.

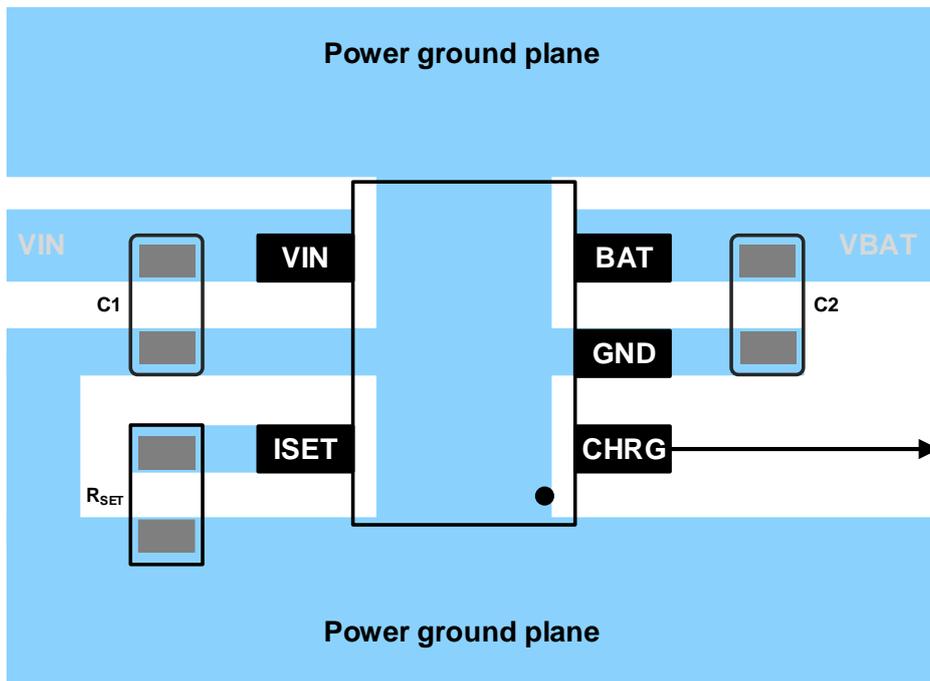
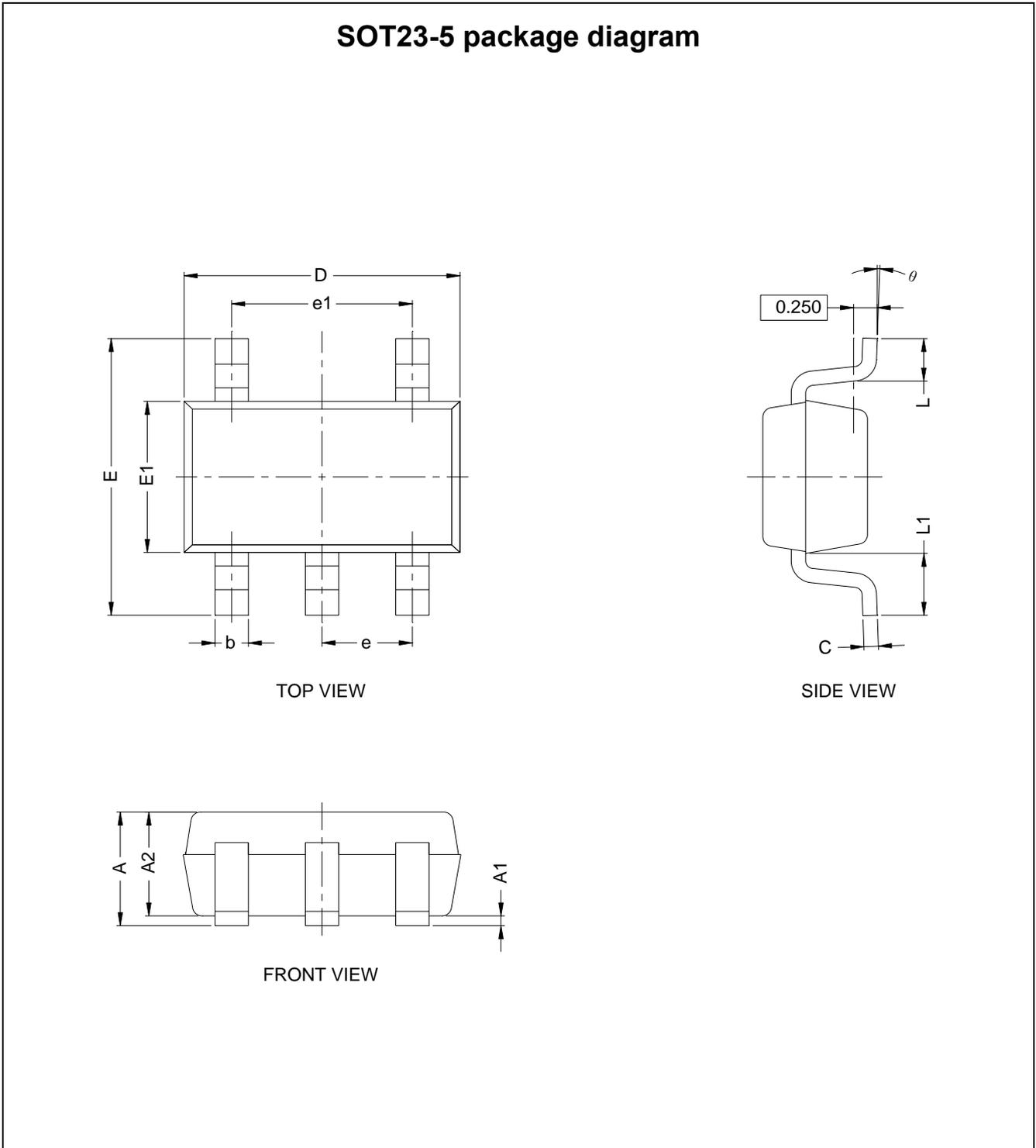


Figure 4. Typical GD30DC1500 Example Layout

## 9 Packaging information

### 9.1 Outline Dimensions



Note :

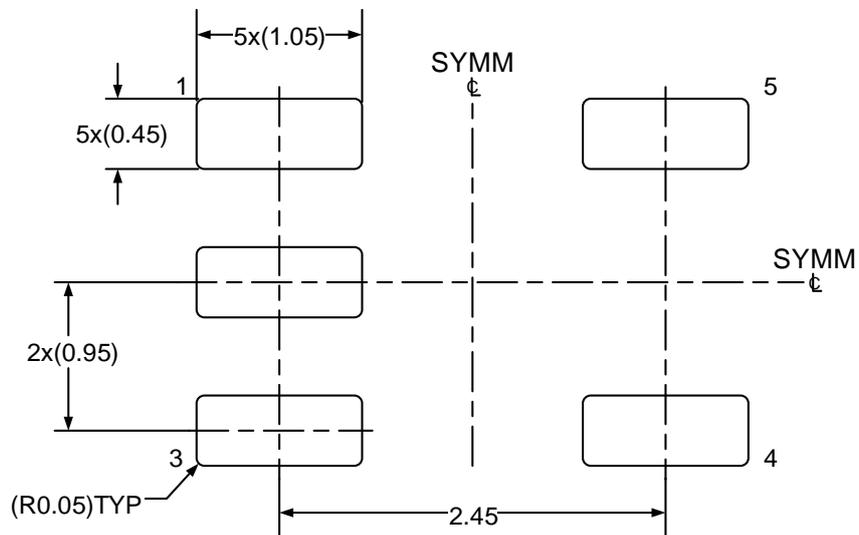
1. All dimensions are in millimeters.
2. Package dimensions does not include mold flash, protrusions, or gate burrs.
3. Refer to [Table 1. SOT23-5 dimensions\(mm\)](#).

**Table 1. SOT23-5 dimensions(mm)**

SYMBOL	MIN	NOM	MAX
A			1.25
A1	0.03	0.08	0.15
A2	1.05	1.10	1.15
b	0.27		0.35
c	0.135		0.23
D	2.82	2.92	3.02
E	2.60	2.90	3.00
E1	1.50	1.62	1.70
e	0.95 BSC		
e1	1.90 BSC		
L	0.35	0.45	0.55
L1	0.49	0.64	0.79
$\theta$	0°		8°

## 9.2 Recommended Land Pattern

### SOT23-5 Land Pattern Example



Note :

1. Refer to the IPC-7351 can also help you complete the designs.
2. Exposed metal shown.
3. Drawing is 20X scale.



## 10 Ordering Information

Ordering Code	Package Type	ECO Plan	Packing Type	MOQ	OP Temp(°C)
GD30BC1500NSTR-I	SOT23-5	Green	Tape & Reel	3000	-40°C to +125°C



## 11 Revision History

REVISION NUMBER	DESCRIPTION	DATE
1.0	Initial release and device details	2023

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